



Data brief

Discovery kits with STM32MP157 MPUs



STM32MP157C-DK2 top view with display removed. Picture is not contractual.

Product status link
STM32MP157A-DK1
STM32MP157C-DK2

Features

- Common features
 - STM32MP157 Arm[®]-based dual Cortex[®]-A7 32 bits + Cortex[®]-M4 32 bits MPU in TFBGA361 package
 - ST PMIC STPMIC1A
 - 4-Gbit DDR3L, 16 bits, 533 MHz
 - 1-Gbps Ethernet (RGMII) compliant with IEEE-802.3ab
 - USB OTG HS
 - Audio codec
 - 4 user LEDs
 - 2 user and reset push-buttons, 1 wake-up button
 - 5 V / 3 A USB Type-C[™] power supply input (not provided)
 - Board connectors:
 - Ethernet RJ45
 - 4 × USB Host Type-A
 - USB Type-C[™] DRP
 - ∘ MIPI DSIsM
 - · HDMI®
 - Stereo headset jack including analog microphone input
 - microSD[™] card
 - GPIO expansion connector (Raspberry Pi[®] shields capability)
 - Arduino[™] Uno V3 expansion connectors
 - On-board ST-LINK/V2-1 debugger/programmer with USB re-enumeration capability: Virtual COM port and debug port
 - STM32CubeMP1 and full mainline open-source Linux[®] STM32 MPU
 OpenSTLinux Distribution (such as STM32MP1Starter) software and
 examples
 - Support of a wide choice of Integrated Development Environments (IDEs) including IAR[™], Keil[®], GCC-based IDEs
- Board-specific features
 - 4" TFT 480×800 pixels with LED backlight, MIPI DSIsM interface, and capacitive touch panel
 - Wi-Fi[®] 802.11b/g/n
 - Bluetooth[®] Low Energy 4.1

Description

The STM32MP157A-DK1 and STM32MP157C-DK2 Discovery kits leverage the capabilities of STM32MP1 Series microprocessors to allow users easily develop applications using STM32 MPU OpenSTLinux Distribution software for the main processor and STM32CubeMP1 software for the co-processor.

They include an ST-LINK embedded debug tool, LEDs, push-buttons, one Ethernet 1-Gbps connector, one USB Type- C^{TM} OTG connector, four USB Type-A Host



connectors, one HDMI[®] transceiver, one stereo headset jack with analog microphone, and one microSDTM connector.

To expand the functionality of the STM32MP157A-DK1 and STM32MP157C-DK2 Discovery kits, two GPIO expansion connectors are also available for Arduino $^{\text{TM}}$ and Raspberry Pi $^{\text{R}}$ shields.

Additionally, the STM32MP157C-DK2 Discovery kit features an LCD display with a touch panel, and Wi-Fi® and Bluetooth® Low Energy capability.

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1 Development environment

STM32 Arm Cortex MPUs are based on the Arm® Cortex®-A and Cortex®-M processors.

Note: Arm is a registered trademark of Arm Limited (or its subsidiaries) in the US and/or elsewhere.

arm

1.1 System requirements

- Windows® OS (7, 8 and 10), Linux® 64-bit, or macOS®
- USB Type-C[™] to USB Type-C[™] charger 5 V / 3 A
- USB Type-C[™] to Type-A cable
- USB Type-A to Micro-B cable

Note: macOS[®] is a trademark of Apple Inc. registered in the U.S. and other countries.

1.2 Development toolchains

- Keil[®] MDK-ARM (see note)
- IAR[™] EWARM (see note)
- GCC-based IDEs
- GCC

Note: On Windows[®] only.

1.3 Demonstration software

The STM32 MPU OpenSTLinux Distribution and STM32CubeMP1 base demonstration software is preloaded in the microSD $^{\text{TM}}$ for easy demonstration of the device peripherals in standalone mode. The latest versions of the demonstration source code and associated documentation can be downloaded from www.st.com.

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2 Ordering information

2.1 STM32MP157 Discovery kit products

To order an STM32MP157 Discovery kit, refer to Table 1. For a detailed description, refer to the user manual on the product web page. Additional information is available from the datasheet and reference manual of the target STM32.

Table 1. List of available products

Order code	Board reference	User manual	Target STM32	Differentiating feature
STM32MP157A-DK1	• MB1272		STM32MP157AAC3	Basic security
STM32MP157C-DK2	• MB1272 • MB1407 ⁽¹⁾	UM2534	STM32MP157CAC3	 Secure Boot and cryptography LCD Wi-Fi[®] Bluetooth[®] Low Energy

^{1.} LCD extension board.

2.2 Product marking

Evaluation tools marked as "ES" or "E" are not yet qualified and therefore not ready to be used as reference design or in production. Any consequences deriving from such usage will not be at ST charge. In no event, ST will be liable for any customer usage of these engineering sample tools as reference design or in production.

"E" or "ES" marking examples of location:

- On the targeted STM32 that is soldered on the board (for illustration of STM32 marking, refer to the STM32 datasheet "Package information" paragraph at the www.st.com website).
- · Next to the evaluation tool ordering part number that is stuck or silk-screen printed on the board.

2.3 Codification

The meaning of the codification is explained in Table 2.

Table 2. Codification explanation

STM32MP1XXY-DKZ	Description	Example: STM32MP157C-DK2
STM32MP1	MPU series in STM32 Arm Cortex MPUs	STM32MP1 Series
XX	MPU line in the series	STM32MP157 line
Y	Security option: A: basic security C: Secure Boot and cryptography	Secure Boot and cryptography
DKZ	Discovery kit configuration: DK1: basic DK2: LCD, Wi-Fi [®] , and Bluetooth [®] Low Energy	LCD, Wi-Fi [®] , and Bluetooth [®] Low Energy

The order code is mentioned on a sticker placed on the top side of the board.

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3 Technology partners

MICRON

4-Gbit DDR3L, 16 bits, part number MT41K256M16TW-107-P-V00H

MURATA

• Wi-Fi® 802.11b/g/n + Bluetooth® Low Energy 4.1, part number LBEE5KL1DX-883

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Revision history

Table 3. Document revision history

Date	Version	Changes
5-Feb-2019	1	Initial release.

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